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To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below Name of conveying party(ies)/Execution Date(s): 2. Name and address of receiving party(ies) **Eun-Young JUNG** Name: Samsung Electronics Co., Ltd. Internal Address: Execution Date(s) July 26, 2006 Street Address: 416, Maetan-dong, Yeongtong-gu Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No 9. Nature of conveyance: City: Suwon-si Assignment ☐ Merger State: Gyeonggi-do ☐ Change of Name Security Agreement Country: Republic of Korea Zip: 442-742 Government Interest Assignment Executive Order 9424, Confirmatory License Additional name(s) & address(es) attached? ☐ Yes ☒ No 4. Application or patent number(s): This document is being filed together with a new application. B. Patent No.(s) A. Patent Application No.(s) Additional numbers attached? ☐ Yes ☒ No 6. Total number of applications and patents 5. Name and address to whom correspondence concerning document should be mailed: involved: 7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00 Name: Roylance, Abrams, Berdo & Goodman, L.L.P. Authorized to be charged by credit card Internal Address: Suite 600 Authorized to be charged to deposit account Street Address: 1300 19th Street, NW None required (government interest not affecting title) 8. Payment Information City: Washington State: D.C. Last 4 Numbers Zip: 20036 a. Credit Card Phone Number: (202) 659-9076 Expiration Date Fax Number: (202) 659-9344 b. Deposit Account Number 18-2220 Authorized User Name Email Address: John E. Holmes July 27, 2006 9. Signature: Date Maeng-Ho Shin, Red. No. 53,859 Total number of pages including cover Name of Person Signing sheet, attachments, and documents:

Documents to be recorded (including cover sheet) should be faxed to (703) 306-5995, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, VA 22313-1450

07/28/2006 EAREGAY1 00000095 11493637 04 FC:8021 40

## **ASSIGNMENT**

WHEREAS, I, Eun-Young JUNG, a citizen of the Republic of Korea, residing at 101-206, Jugong 1-danji Apt., Uman 2-dong, Paldal-gu, Suwon-si, Gyeonggi-do, Republic of Korea (hereinafter "ASSIGNOR"), have made a certain invention entitled "METHOD AND APPARATUS FOR MANAGING PRIVATE DATA IN MULTI-FUNCTION PRODUCTS" for which I am making application for Letters Patent of the United States, which application is being executed concurrently herewith; and

WHEREAS, Samsung Electronics Co., Ltd., a corporation duly organized under the laws of the Republic of Korea, located and doing business at 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea (hereinafter "ASSIGNEE"), is desirous of acquiring the entire right, title and interest in and to the aforementioned invention and the aforementioned application and any and all United States Letters Patent to be obtained on said invention and/or application;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN:

BE IT KNOWN that for good and valuable consideration paid to me by said ASSIGNEE, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, by these presents do hereby sell, assign, set over and transfer unto the said ASSIGNEE, its successors, legal representatives or assigns, the entire right, title and interest in and to the aforesaid invention in and for the United States; and in, to and under the aforesaid United States application and any divisional, continuing, substitute or reissue applications or supplementary disclosures which may be filled on said invention in the United States; and our right to file said applications and claim priority under the provisions of any international treaty or convention; and in and to any Letters Patent of the United States issued or granted on said invention and/or said applications;

AND I HEREBY authorize and request the U.S. Patent and Trademark Office or other issuing authority to issue any and all patents on said invention and/or said applications to said ASSIGNEE as sole assignee;

AND I HEREBY covenant that I have the full right to convey the entire right, title and interest herein assigned and that I have not executed and will not execute any assignment or other instrument in conflict herewith;

AND I HEREBY further covenant and agree to communicate to said ASSIGNEE, or its legal representatives, successors or assigns, any facts relating to said invention, including evidence for interference purposes or other proceedings, whenever requested, and to testify in any interference or in any other legal proceeding, when requested, and to execute and deliver on request all lawful papers required to make any of the foregoing provisions effective; and to perform the aforesaid communicating, executing and delivering, without any payment except expenses and to perform the aforesaid testifying for reasonable compensation; and

**ASSIGNMENT** 

PATENT REEL: 018137 FRAME: 0429 generally to do everything possible to aid the said ASSIGNEE, its successors, legal representatives or assigns to obtain and enforce proper patent protection on and for said invention in the United States, and likewise I make these provisions binding upon our heirs, legal representatives and/or administrators.

I hereby grant the firm of Roylance, Abrams, Berdo & Goodman, L.L.P. the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Tradernark Office for recordation of this document.

IN WITNESS WHEREOF, I have hereunder set my hand and seal this 26thday of

Witness

**TARMADICES** 

**PATENT** 

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WHEREAS, I, Eun-Young JUNG, a citizen of the Republic of Korea, residing at 101-206, Jugong 1-danji Apt., Uman 2-dong, Paldal-gu, Suwon-si, Gyeonggi-do, Republic of Korea (hereinafter "ASSIGNOR"), have made a certain invention entitled "METHOD AND APPARATUS FOR MANAGING PRIVATE DATA IN MULTI-FUNCTION PRODUCTS" for which I am making application for Letters Patent of the United States, which application is being executed concurrently herewith; and

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NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN:

BE IT KNOWN that for good and valuable consideration paid to me by said ASSIGNEE, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, by these presents do hereby sell, assign, set over and transfer unto the said ASSIGNEE, its successors, legal representatives or assigns, the entire right, title and interest in and to the aforesaid invention in and for the United States; and in, to and under the aforesaid United States application and any divisional, continuing, substitute or reissue applications or supplementary disclosures which may be filed on said invention in the United States; and our right to file said applications and claim priority under the provisions of any international treaty or convention; and in and to any Letters Patent of the United States issued or granted on said invention and/or said applications;

AND I HEREBY authorize and request the U.S. Patent and Trademark Office or other issuing authority to issue any and all patents on said invention and/or said applications to said ASSIGNEE as sole assignee;

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ASSIGNMENT

PATENT REEL: 018137 FRAME: 0431 generally to do everything possible to aid the said ASSIGNEE, its successors, legal representatives or assigns to obtain and enforce proper patent protection on and for said invention in the United States, and likewise I make these provisions binding upon our heirs, legal representatives and/or administrators.

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IN WITNESS WHEREOF, I have hereunder set my hand and seal this 26th day of July , 2006.

Edn-Yoping JUNG

Witness

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